





## SUPER FLUX LED LAMP

## **Features**

- High current operation for greater luminous output
- Low Power Consumption and thermal resistance

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- Can be used with automatic insertion equipment
- RoHS Compliant





### **Benefits:**

- •Rugged design allows for easy maintenance
- •Robust package for optimum reliability

# **Typical Applications:**

- •Automotive side markers
- •Gaming and entertainment lighting
- •Signs and road hazard indicators



# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

# 7.62[0.3] C1.2 7.62[0.3] R0.7[R0.028] ø3.2[0.126] 5[0.197]4.4[0.173] 0.4[0.016] 1.5[0.059] 0.4[0.016] 5.08[0.2] 0.75[0.03] CATHODE 5.08[0.2]

### Notes:

1. All dimensions are in millimeters (inches).

Package Schematics

- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Rating (T <sub>A</sub> =25°C)	FBB (InGaN)	Unit		
Reverse Voltage	$V_{R}$	5	V	
DC Forward Current	$I_{\mathrm{F}}$	30	mA	
Power Dissipation	PD	135	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-55 ~ +85		
Electrostatic Discharge Thres (HBM)	250	V		
Lead Solder Temperature [1.5mm Below Seating Plane.]	260°C For 5 Seconds			

Operating Characteristics $(T_A=25^{\circ}C)$		FBB (InGaN)		
Forward Voltage (Typ.) (I <sub>F</sub> =30mA)	$V_{\mathrm{F}}$	3.5	V	
Forward Voltage (Max.) (I <sub>F</sub> =30mA)	$V_{\mathrm{F}}$	4.5	V	
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	50	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I <sub>F</sub> =30mA)	λР	465*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I <sub>F</sub> =30mA)	λD	470*	nm	
Spectral Line Full Width At Half Maximum (Typ.) (I <sub>F</sub> =30mA)	Δλ	22	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	100	pF	
Thermal Resistance (Typ.)	Rθj-pin	180	°C/W	

1.No Reflow soldering.

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =30mA) cd		Luminous Flux CIE127-2007* (I <sub>F</sub> =30mA) lm	Wavelength CIE127-2007* λP nm	Viewing Angle 20 1/2
				min.	typ.	typ.		
XSFBB783W	Blue	InGaN	Water Clear	2.5*	3.6*	1.5*	465*	30°

<sup>1.</sup>Luminous intensity is measured with an integrating sphere after the device has stabilized.

May 03,2012 XDSB5342 V3-Z Layout: Maggie L.

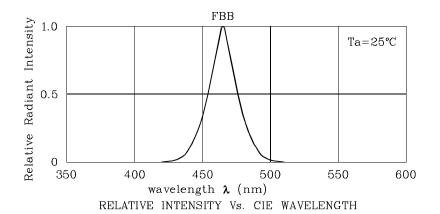
 $<sup>2.0\,1/2</sup>$  is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

<sup>3.</sup> LEDs are binned according to their Luminous intensity.

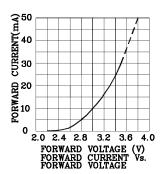
<sup>\*</sup>Luminous intensity / luminous flux value and wavelength are in accordance with CIE127-2007 standards.

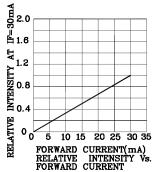


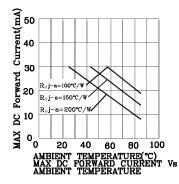


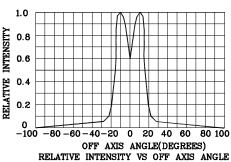


### ❖ FBB

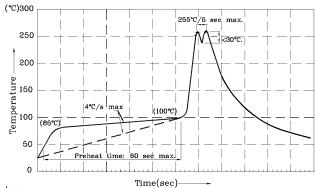








Wave Soldering Profile For Thru-Hole Products (Pb-Free Components)



- Notes:
  1.Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C
- 2.Peak wave soldering temperature between 245°C  $\sim$  255°C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above 85°C. 4.Fixtures should not incur stress on the component when mounting and during soldering process.
  5.SAC 305 solder alloy is recommended.
  6.No more than one wave soldering pass.

#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.





## PACKING & LABEL SPECIFICATIONS

